

Vishay Siliconix

Dual P-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|------------------------------------|------------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}$ (Ω) | I _D (A) ^{d, e} | Q _g (Typ.) | | | |
| - 30 | 0.029 at V _{GS} = - 10 V | - 8 | 15 nC | | | |
| - 30 | 0.041 at V _{GS} = - 4.5 V | - 8 | 13110 | | | |

FEATURES

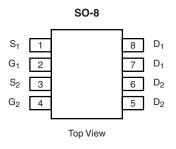
- Halogen-free
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

Pb-free

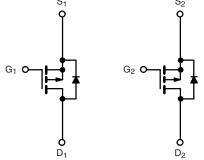
RoHS

APPLICATIONS

- · Load Switches
 - Notebook PCs
 - Desktop PCs
 - Game Stations



Ordering Information: Si4925DDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS | $\Gamma_A = 25 ^{\circ}\text{C}$, unless other | erwise noted | | |
|--|--|-------------------|-----------------------|----|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | - 30 | V | |
| Gate-Source Voltage | V _{GS} | ± 20 | v | |
| | T _C = 25 °C | | - 8.0 ^e | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 70 °C | | - 8.0 ^e | |
| Continuous Diain Current (1) = 130 C) | T _A = 25 °C | l lD | - 7.3 ^{a, b} | |
| | T _A = 70 °C | | - 5.9 ^{a, b} | Α |
| Pulsed Drain Current | I _{DM} | - 32 ^e | | |
| Continuous Course Drain Diade Current | T _C = 25 °C | I. | - 4.1 | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | - 2.0 ^{a, b} | |
| Avalanche Current | L = 0.1 mH | I _{AS} | - 20 | |
| Single-Pulse Avalanche Energy | L = 0.1 IIII | E _{AS} | 20 | mJ |
| | T _C = 25 °C | | 5.0 | |
| Maximum Davin Dissination | T _C = 70 °C | | 3.2 | w |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 2.5 ^{a, b} | VV |
| | T _A = 70 °C | | 1.6 ^{a, b} | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 38 | 50 | °C/W | |
| Maximum Junction-to-Foot | Steady State | R _{thJF} | 20 | 25 | C/VV | |

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 85 °C/W.
- d. Based on T_C = 25 °C.
- e. Limited by package.

Si4925DDY

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-------------------------|--|-------|--------|-------|-------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V, } I_D = -250 \mu\text{A}$ | - 30 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 μA | | - 31 | | \//00 | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = - 250 μA | | 4.5 | | mV/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 1.0 | | - 3.0 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| 7 0 1 1/1 5 1 0 1 | | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ | -1 | | - 1 | μА | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C | | | - 5 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$ | - 30 | | | Α | |
| | _ | V _{GS} = - 10 V, I _D = - 7.3 A | | 0.024 | 0.029 | .0. | |
| Drain-Source On-State Resistance ^a | H _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 6.2 A | | 0.033 | 0.041 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 9.1 A | | 23 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 1350 | | | |
| Output Capacitance | C _{oss} | $V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 215 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 185 | | | |
| Tatal Oats Observe | | $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -9.1 \text{ A}$ | | 32 50 | 50 | 1 | |
| Total Gate Charge | Q_g | | | 15 | 25 | | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -9.1 \text{ A}$ | | 4 | | nC | |
| Gate-Drain Charge | Q _{gd} | | | 7.5 | | 1 | |
| Gate Resistance | R_{g} | f = 1 MHz | | 5.8 | | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | | |
| Rise Time | ì, | $V_{DD} = -15 \text{ V}, R_{L} = 15 \Omega$ | | 8 | 15 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 45 | 70 | | |
| Fall Time | t _f |] | | 12 | 25 | | |
| Turn-On Delay Time | t _{d(on)} | | | 42 | 70 | ns | |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 15 Ω | | 35 | 60 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 1 Ω | | 40 | 70 | | |
| Fall Time | t _f |] | | 16 | 30 | | |
| Drain-Source Body Diode Characterist | ics | | | | | | |
| Continous Source-Drain Diode Current | I _S | T _C = 25 °C | | | - 4.1 | | |
| Pulse Diode Forward Current | I _{SM} | _ | | | - 32 | Α | |
| Body Diode Voltage | V _{SD} | I _S = - 2 A, V _{GS} = 0 V | | - 0.75 | - 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 34 | 60 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 22 | 40 | nC | |
| Reverse Recovery Fall Time | t _a | $I_F = -2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | | 11 | | | |
| Reverse Recovery Rise Time | t _b | | | 23 | | ns | |

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

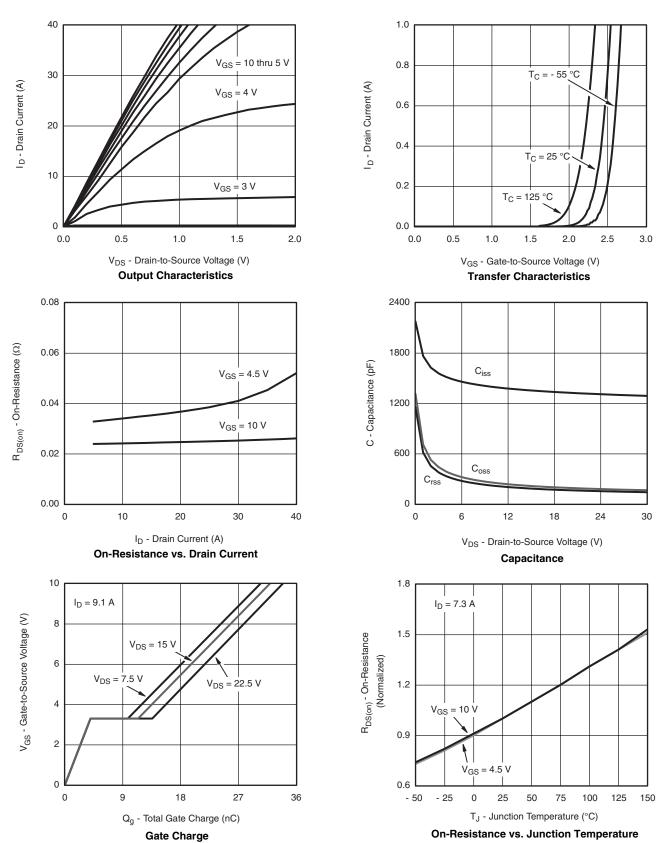
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



0.10

100

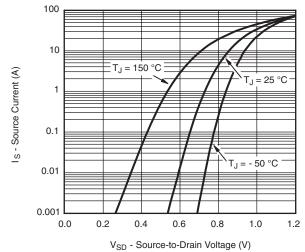
80

60

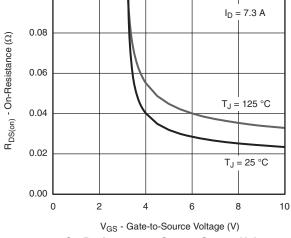
Si4925DDY

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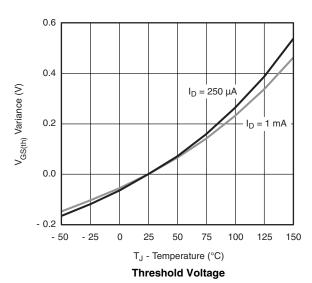
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Source-Drain Diode Forward Voltage



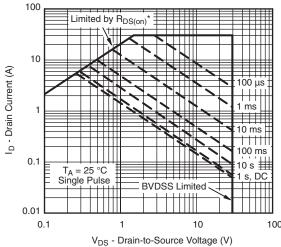
On-Resistance vs. Gate-to-Source Voltage



Power (W) 40 20 0 0.1 0.001 0.01

Time (s) Single Pulse Power, Junction-to-Ambient

10



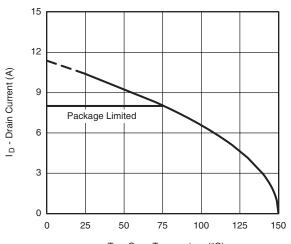
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area



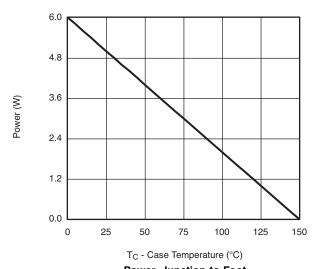
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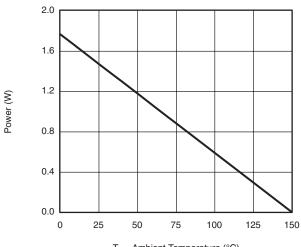
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $T_{\mbox{\scriptsize C}}$ - Case Temperature (°C)

Current Derating*





T_A - Ambient Temperature (°C)

Power, Junction-to-Foot

Power Derating, Junction-to-Ambient

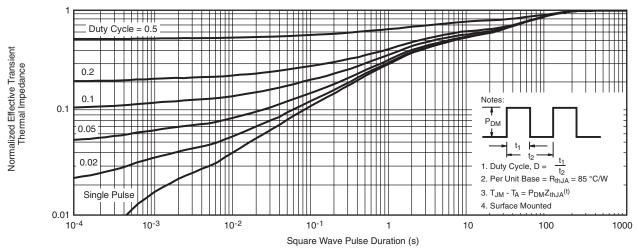
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si4925DDY

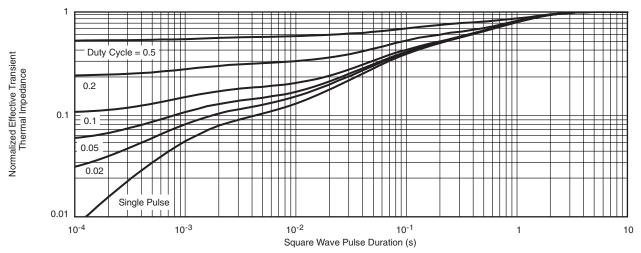
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

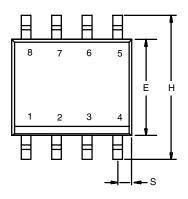


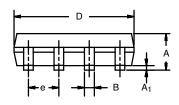
Normalized Thermal Transient Impedance, Junction-to-Foot

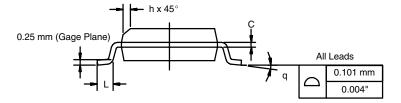
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







| | MILLIM | IETERS | INCHES | | | |
|--------------------------------|--------|-------------|--------|-------|--|--|
| DIM | Min | Max | Min | Max | | |
| Α | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| Е | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC 0.050 B | | 3SC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Rev. I. 11-Sep-06 | | | | | | |

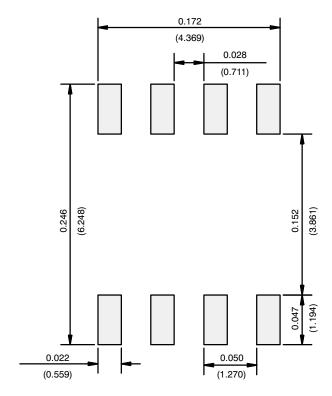
DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

LON NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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